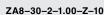






ZA8-20-1-1.00-Z-10-2





(0.80 mm) .0315"

ZA8 SERIES

- 1

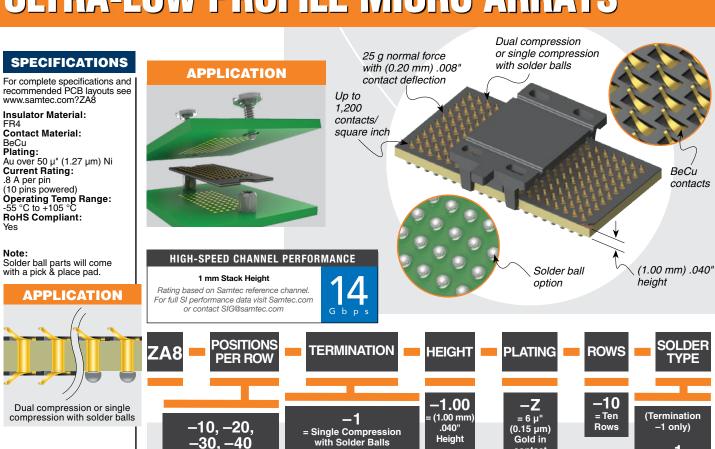
= Lead

-2

= Lead-Free

ZA8-10-2-1.00-Z-10

ULTRA-LOW PROFILE MICRO ARRAYS



DESIGN FLEXIBILITY

The Z-Ray® platform is highly-customizable:

PITCH	≥ 0.65 mm	
STACK HEIGHT	0.50 mm to 4.00 mm	
DENSITY	Up to 1,200 contacts/square inch	
RUGGEDIZING	Latches, Thermal Spreaders, Quick-release Spring Constraints	
CONSTRUCTION	Multi-layer FR4 (e.g., Pitch Spreaders)	

Contact Samtec.

(1.07)- (4.00) .157 .042 DIA DIA (2.00) .079 DIA (0.80) .0315 40 X 10 DUAL COMPRESSION BOTH SIDES

(-10 & -20 positions only)

-2

= Dual Compression

(-10, -20, -30

40 positions only)

(1.00) .039

Gold in

contact

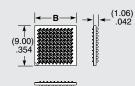
area

20 x 10 DUAL COMPRESSION

→ (0.80) .0315

-30. -40

20 X 10 COMPRESSION WITH SOLDER BALLS



Height

10 x 10 COMPRESSION WITH SOLDER BALLS

Α	В
(12.50) .492	(9.35) .368
(20.50) .807	(17.35) .683
(31.70) 1.248	N/A
(39.70) 1.563	N/A
	(12.50) .492 (20.50) .807 (31.70) 1.248 (39.70)

Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice. WWW.SAMTEC.COM